



LTC1350

3.3V Low Power EIA/TIA-562 3-Driver/ 5-Receiver Transceiver

FEATURES

- Low Supply Current **300µA**
- Receivers 4 and 5 Kept Alive in SHUTDOWN
- ESD Protection **35µA**
- Operates from a Single 3.3V Supply **±10kV**
- Uses Small Capacitors **0.1µF**
- Operates to 120k Baud
- Three-State Outputs are High Impedance When Off
- Output Overvoltage Does Not Force Current Back into Supplies
- EIA/TIA-562 I/O Lines Can Be Forced to ±25V Without Damage
- Flowthrough Architecture

APPLICATIONS

- Notebook Computers
- Palmtop Computers

DESCRIPTION

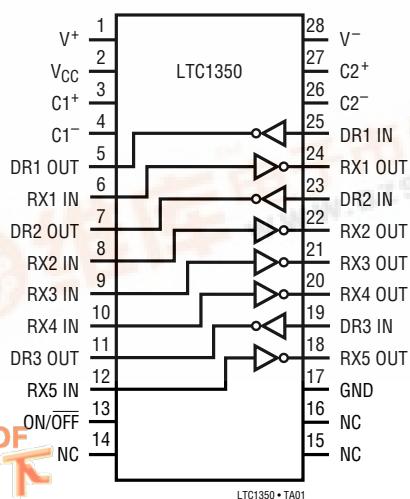
The LTC1350 is a 3-driver/5-receiver EIA/TIA-562 transceiver with very low supply current. In the no load condition, the supply current is only 300µA. The charge pump only requires four 0.1µF capacitors.

In SHUTDOWN mode, two receivers are kept alive and the supply current is only 35µA. All RS232 outputs assume a high impedance state in SHUTDOWN or with the power off.

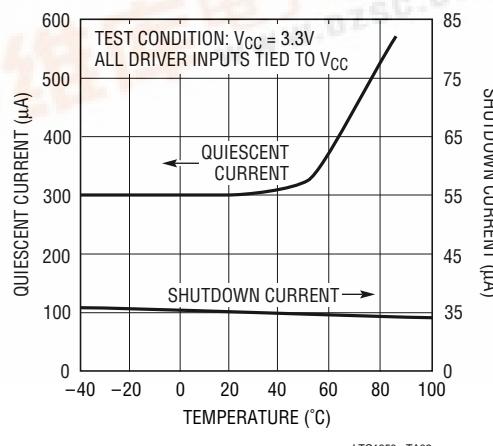
The LTC1350 is fully compliant with all data rate and overvoltage EIA/TIA-562 specifications. The transceiver can operate up to 120k baud with a 1000pF and 3kΩ load. Both driver outputs and receiver inputs can be forced to ±25V without damage and can survive multiple ±10kV ESD strikes.

TYPICAL APPLICATION

3-Drivers/5-Receiver with Shutdown



Quiescent and Shutdown Supply Current vs Temperature



LTC1350

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{CC})	5V
Input Voltage	
Driver	-0.3V to V_{CC} + 0.3V
Receiver	-25V to 25V
ON/OFF Pin	-0.3V to V_{CC} + 0.3V
Output Voltage	
Driver	-25V to 25V
Receiver	-0.3V to V_{CC} + 0.3V
Short-Circuit Duration	
V^+	30 sec
V^-	30 sec
Driver Output	Indefinite
Receiver Output	Indefinite
Operating Temperature Range	
Commercial (LTC1350C)	0°C to 70°C
Industrial (LTC1350I)	-40°C to 85°C
Storage Temperature Range	-65°C to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

TOP VIEW	ORDER PART NUMBER
	LTC1350CG
	LTC1350CN
	LTC1350CS
	LTC1350IG
	LTC1350IN
	LTC1350IS

G PACKAGE N PACKAGE
 28-LEAD SSOP 28-LEAD PLASTIC DIP
 S PACKAGE
 28-LEAD PLASTIC SOL

$T_{JMAX} = 125^\circ\text{C}, \theta_{JA} = 96^\circ\text{C/W}$ (G)
 $T_{JMAX} = 125^\circ\text{C}, \theta_{JA} = 56^\circ\text{C/W}$ (N)
 $T_{JMAX} = 125^\circ\text{C}, \theta_{JA} = 85^\circ\text{C/W}$ (S)

Consult factory for Military grade parts

DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.3\text{V}$, $C1 = C2 = C3 = C4 = 0.1\mu\text{F}$, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Any Driver						
Output Voltage Swing	3k to GND	Positive Negative	● ●	3.7 -3.7	4.5 -4.5	V
Logic Input Voltage Level	Input Low Level ($V_{OUT} = \text{High}$) Input High Level ($V_{OUT} = \text{Low}$)		● ●		1.4 2.0	0.8 1.4
Logic Input Current	$V_{IN} = V_{CC}$ $V_{IN} = 0\text{V}$		● ●		5 -5	μA
Output Short-Circuit Current	$V_{OUT} = 0\text{V}$				± 10	mA
Output Leakage Current	SHUTDOWN (Note 3), $V_{OUT} = \pm 20\text{V}$				10	500
Any Receiver						
Input Voltage Thresholds	Input Low Threshold Input High Threshold		● ●	0.8 1.7	1.3 2.4	V
Hysteresis			●	0.1	0.4	1
Input Resistance	$V_{IN} = \pm 10\text{V}$			3	5	7
Output Voltage	Output Low, $I_{OUT} = -1.6\text{mA}$ ($V_{CC} = 3.3\text{V}$) Output High, $I_{OUT} = 160\mu\text{A}$ ($V_{CC} = 3.3\text{V}$)		● ●		0.2 3.0	0.4 3.2
Output Short-Circuit Current	Sinking Current, $V_{OUT} = V_{CC}$			-3	-20	mA
Output Leakage Current	SHUTDOWN (Note 3), $0\text{V} \leq V_{OUT} \leq V_{CC}$		●		1	10

DC ELECTRICAL CHARACTERISTICS $V_{CC} = 3.3V$, $C1 = C2 = C3 = C4 = 0.1\mu F$, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Power Supply Generator						
V^+ Output Voltage	$I_{OUT} = 0mA$ $I_{OUT} = 5mA$		5.7	5.5		V
V^- Output Voltage	$I_{OUT} = 0mA$ $I_{OUT} = -5mA$		-5.3	-5.0		V
Supply Rise Time	SHUTDOWN to Turn-On		0.2			ms
Power Supply						
V_{CC} Supply Current	No Load (All Drivers $V_{IN} = V_{CC}$) (Note 2) $0^\circ C \leq T_A \leq 70^\circ C$	●	0.3	0.6		mA
	No Load (All Drivers $V_{IN} = 0$) (Note 2) $0^\circ C \leq T_A \leq 70^\circ C$	●	0.5	1.0		mA
	No Load (All Drivers $V_{IN} = V_{CC}$) (Note 2) $-40^\circ C \leq T_A \leq 85^\circ C$	●	0.3	1.0		mA
	No Load (All Drivers $V_{IN} = 0$) (Note 2) $-40^\circ C \leq T_A \leq 85^\circ C$	●	0.5	1.5		mA
	SHUTDOWN (Note 3)	●	35	50		μA
ON/OFF Threshold Low		●	1.4	0.8		V
ON/OFF Threshold High		●	2.0	1.4		V

AC CHARACTERISTICS $V_{CC} = 5V$, $C1 = C2 = C3 = C4 = 0.1\mu F$, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Slew Rate	$R_L = 3k$, $C_L = 51pF$ $R_L = 3k$, $C_L = 1000pF$		8	30		$V/\mu s$
			3	5		$V/\mu s$
Driver Propagation Delay (TTL to EIA/TIA-562)	t_{HLD} (Figure 1) t_{LHD} (Figure 1)	● ●	2 2	3.5 3.5		μs
Receiver Propagation Delay (EIA/TIA-562 to TTL)	t_{HLR} (Figure 2) t_{LHR} (Figure 2)	● ●	0.3 0.3	0.8 0.8		μs

The ● denotes specifications which apply over the operating temperature range of $0^\circ C \leq T_A \leq 70^\circ C$ for commercial grade, $-40^\circ C \leq T_A \leq 85^\circ C$ for Industrial grade.

Note 1: Absolute maximum ratings are those values beyond which the life of the device may be impaired.

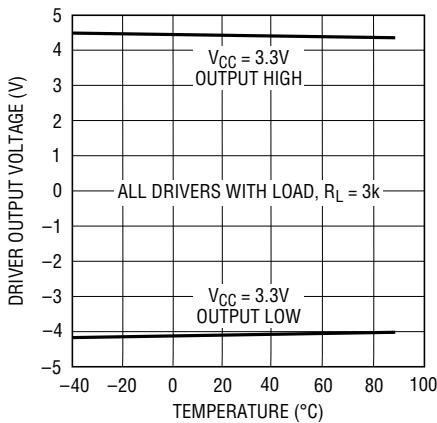
Note 2: Supply current is measured with driver and receiver outputs unloaded.

Note 3: Supply current measurement in SHUTDOWN mode is performed with $V_{ON/OFF} = 0V$.

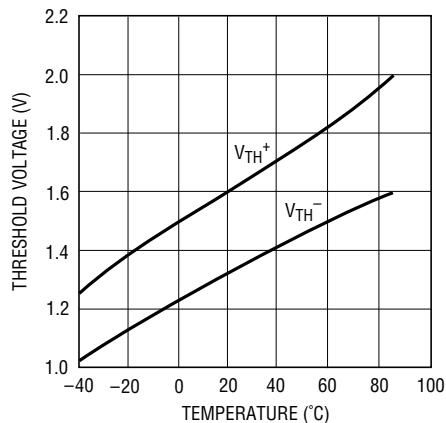
LTC1350

TYPICAL PERFORMANCE CHARACTERISTICS

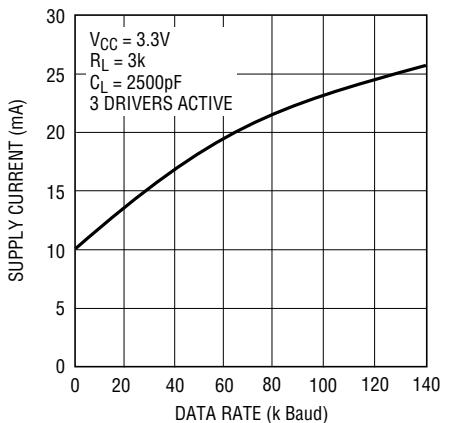
Driver Output Voltage vs Temperature



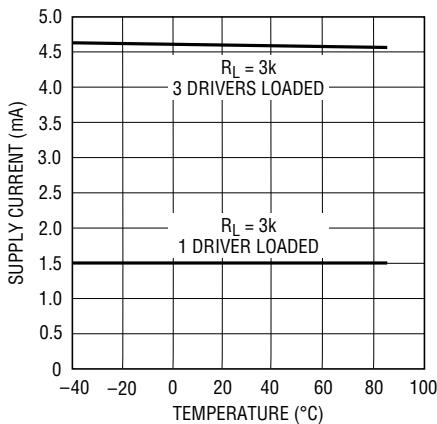
Receiver Input Thresholds vs Temperature



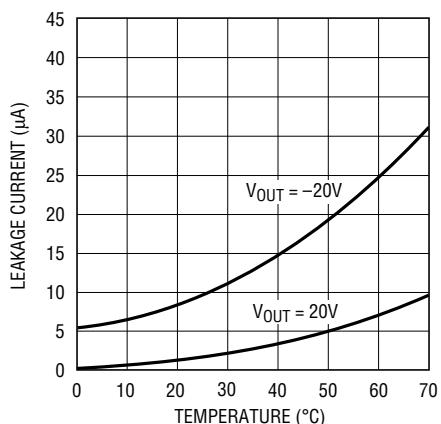
Supply Current vs Data Rate



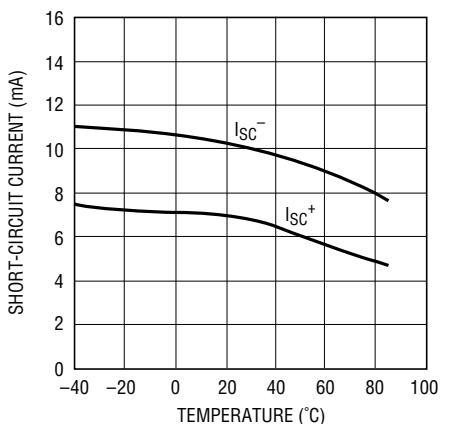
V_{CC} Supply Current vs Temperature



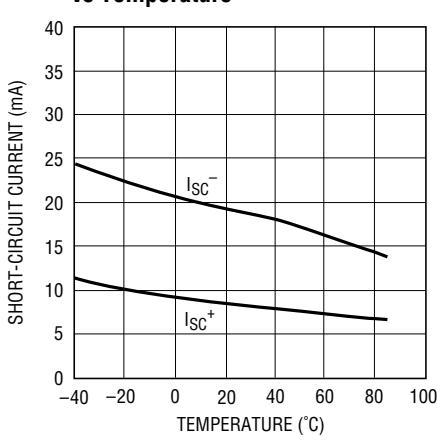
Driver Leakage in Shutdown vs Temperature



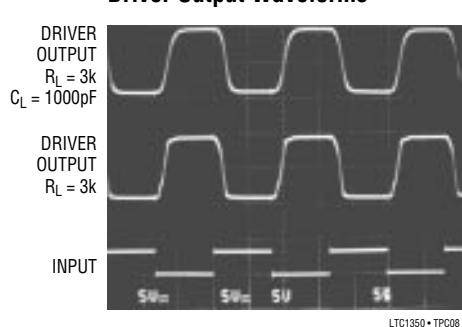
Driver Short-Circuit Current vs Temperature



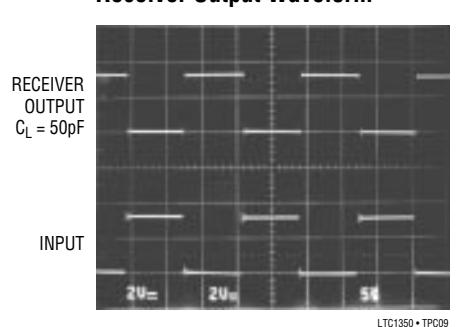
Receiver Short-Circuit Current vs Temperature



Driver Output Waveforms



Receiver Output Waveform



LTC1350 • TPC07

LTC1350 • TPC09

PIN FUNCTIONS

V_{CC}: 3.3V Input Supply Pin. Supply current is typically 35µA in the SHUTDOWN mode. This pin should be decoupled with a 0.1µF ceramic capacitor.

GND: Ground Pin.

ON/OFF: TTL/CMOS Compatible Shutdown Pin. A logic low puts the device in the SHUTDOWN mode with receivers 4 and 5 kept alive and the supply current equal to 35µA. All driver and other receiver outputs are in high impedance state. This pin cannot float.

V⁺: Positive Supply Output. $V^+ \approx 2V_{CC} - 1V$. This pin requires an external capacitor ($C = 0.1\mu F$) for charge storage. The capacitor may be tied to ground or V_{CC} . With multiple devices, the V^+ and V^- pins may be paralleled into common capacitors. For a large number of devices, increasing the size of the shared common storage capacitors is recommended to reduce ripple.

V⁻: Negative Supply Output. $V^- \approx -(2V_{CC} - 1.3V)$. This pin requires an external capacitor ($C = 0.1\mu F$) for charge storage.

C1⁺, C1⁻, C2⁺, C2⁻: Commutating Capacitor Inputs. These pins require two external capacitors ($C = 0.1\mu F$): one from $C1^+$ to $C1^-$ and another from $C2^+$ to $C2^-$. To maintain charge pump efficiency, the capacitor's effective series resistance should be less than 20Ω .

DR IN: EIA/TIA-562 Driver Input Pins. Inputs are TTL/CMOS compatible. Inputs should not be allowed to float. Tie unused inputs to V_{CC} .

DR OUT: Driver Outputs at EIA/TIA-562 Voltage Levels. Outputs are in a high impedance state when in the SHUTDOWN mode or $V_{CC} = 0V$. The driver outputs are protected against ESD to $\pm 10kV$ for human body model discharges.

RX IN: Receiver Inputs. These pins can be forced to $\pm 25V$ without damage. The receiver inputs are protected against ESD to $\pm 10kV$ for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity.

RX OUT: Receiver Outputs with TTL/CMOS Voltage Levels. Receiver 1, 2 and 3 outputs are in a high impedance state when in SHUTDOWN mode to allow data line sharing. Receivers 4 and 5 are kept alive in SHUTDOWN.

SWITCHING TIME WAVEFORMS

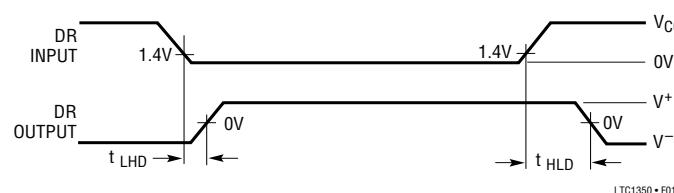


Figure 1. Driver Propagation Delay Timing

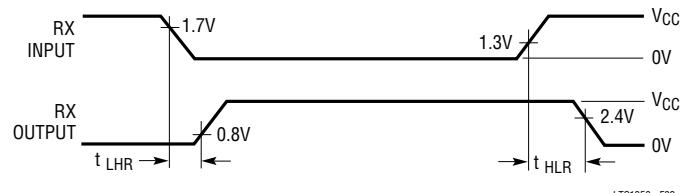
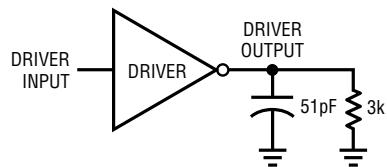


Figure 2. Receiver Propagation Delay Timing

LTC1350

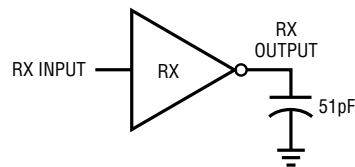
TEST CIRCUITS

Driver Timing Test Load



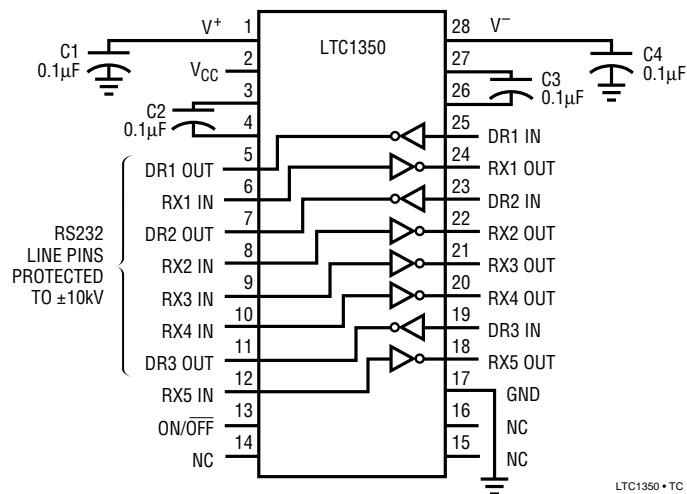
LTC1350 • TA03

Receiver Timing Test Load



LTC1350 • TA04

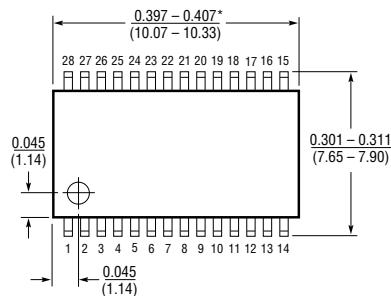
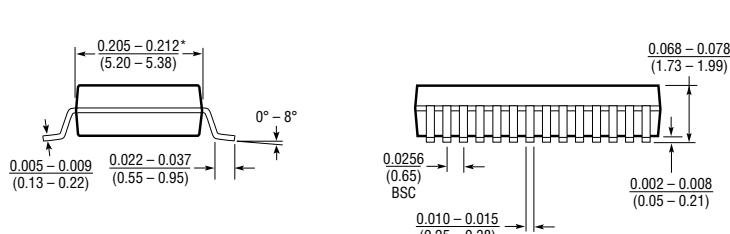
ESD Test Circuit



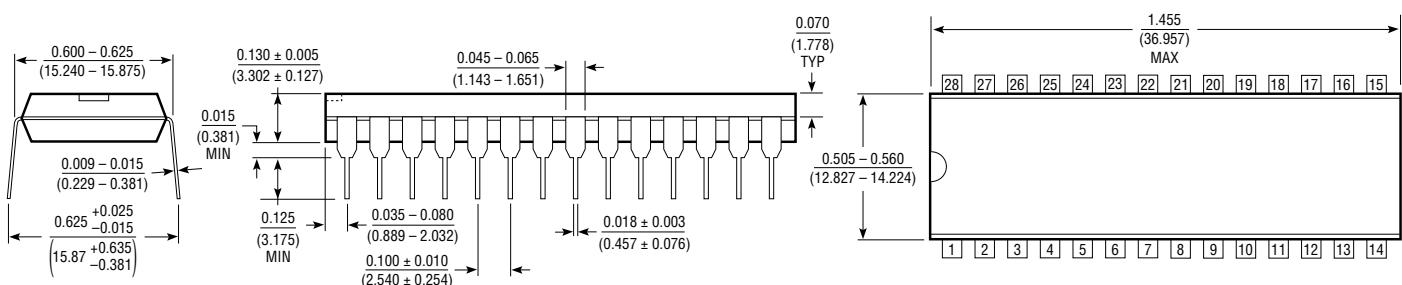
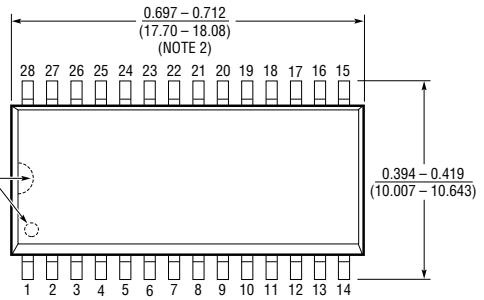
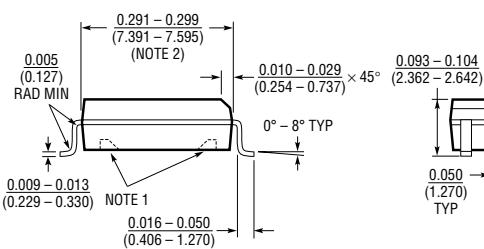
LTC1350 • TC

PACKAGE DESCRIPTION

Dimensions in inches (millimeters) unless otherwise noted.

**G Package
28-Lead SSOP**

*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
 MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.006 INCH (0.15mm).

**N Package
28-Lead Plastic DIP****S Package
28-Lead Plastic SOL**

NOTE:
 1. PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS.

THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS.

2. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.006 INCH (0.15mm).

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